

April 2016

FDG6301N_F085

Dual N-Channel, Digital FET

Features

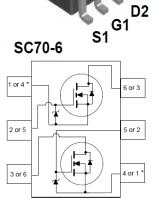
- 25 V, 0.22 A continuous, 0.65 A peak.
- $R_{DS(ON)} = 4 \Omega @ V_{GS} = 4.5 V$,
- $R_{DS(ON)} = 5 \Omega @ V_{GS} = 2.7 V.$
- Very low level gate drive requirements allowing directoperation in 3 V circuits (V_{GS(th)} < 1.5 V).
- Gate-Source Zener for ESD ruggedness (>6kV Human Body Model).
- Compact industry standard SC70-6 surface mount package.
- Qualified to AEC Q101
- RoHS Compliant





Applications

■ Low voltage applications as a replacement for bipolar digital transistors and small signal MOSFETs



S2

G2

MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

| Symbol | Parameter | Ratings | Units |
|---|--|-------------|-------|
| V _{DSS} | Drain to Source Voltage | 25 | V |
| V _{GS} | Gate to Source Voltage | 8 | V |
| | Drain Current Continuous | 0.22 | ^ |
| ID | Pulsed | 0.65 | Α |
| P _D | Power Dissipation | 0.3 | W |
| T _J , T _{STG} Operating and Storage Temperature | | -55 to +150 | °C |
| ESD | Electrostatic Discharge Rating MIL-STD-883D Human Body Model(100 pF / 1500 W) | 6.0 | kV |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 415 | °C/W |

Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|---------------|---------|-----------|------------|------------|
| FDG6301N | FDG6301N_F085 | SC70-6 | 7" | 8mm | 3000 units |

- 1: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. $R_{\theta JA}$ = 415 $^{\circ}$ C/W on minimum pad mounting on FR-4 board in still air
- 2: A suffix as "...F085P" has been temporarily introduced in order to manage a double source strategy as Fairchild has officially announced
- 3: Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%.

Units

Max

Тур

Electrical Characteristics $T_A = 25^{\circ}C$ unless otherwise noted

Parameter

| Off Characteristics | | | | | | | |
|---------------------|-----------------------------------|---------------------------|---------------------|----|---|------|----|
| B _{VDSS} | Drain to Source Breakdown Voltage | $I_D = 250 \mu A, V_{GS}$ | = 0V | 25 | - | - | V |
| I _{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 20V$, | | - | - | 1 | μА |
| | | $V_{GS} = 0V$ | $T_J = 55^{\circ}C$ | - | - | 10 | μА |
| I _{GSS} | Gate to Source Leakage Current | $V_{GS} = \pm 8V$ | | - | - | ±100 | nA |

Test Conditions

Min

On Characteristics

Symbol

| $V_{GS(th)}$ | Gate to Source Threshold Voltage | $V_{GS} = V_{DS}, I_{D} = 250 \mu A$ | 0.65 | 0.85 | 1.5 | V |
|---------------------|----------------------------------|--|------|------|-----|----|
| r _{DS(on)} | | I _D = 0.22A, V _{GS} = 4.5V | - | 2.6 | 4 | |
| | | $I_D = 0.19A, V_{GS} = 2.7V$ | - | 3.7 | 5 | Ω |
| | | $I_D = 0.22A, V_{GS} = 4.5V$ $T_J = 125$ °C | - | 5.3 | 7 | 32 |
| I _{D(on)} | On-State Drain Current | $V_{GS} = 4.5V, V_{DS} = 5V$ | 0.22 | - | - | |
| 9 _{FS} | Forward Transconductance | I _D = 0.22A, V _{DS} = 5V | - | 0.2 | - | S |

Dynamic Characteristics

| C _{iss} | Input Capacitance | $V_{DS} = 10V, V_{GS} = 0V,$ f = 1MHz | | - | 9.5 | - | pF |
|------------------|-------------------------------|--|------------------|---|------|-----|----|
| Coss | Output Capacitance | | | - | 6 | - | pF |
| C _{rss} | Reverse Transfer Capacitance | | | - | 1.3 | - | pF |
| $Q_{g(TOT)}$ | Total Gate Charge at -4.5V | $V_{GS} = 0 \text{ to } 4.5V$ | \/ - F \/ | - | 0.29 | 0.4 | nC |
| Q_{gs} | Gate to Source Gate Charge | $V_{DD} = 5V$ $I_{D} = 0.22A$ | | - | 0.12 | - | nC |
| Q_{gd} | Gate to Drain "Miller" Charge | | | - | 0.03 | - | nC |

Switching Characteristics

| t _{d(on)} | Turn-On Delay Time | | - | 5 | 10 | ns |
|---------------------|---------------------|--|---|-----|----|----|
| t _r | Rise Time | $V_{DD} = 5V, I_D = 0.5A$ | - | 4.5 | 10 | ns |
| t _{d(off)} | Turn-Off Delay Time | V_{GS} = 4.5V, R_{GEN} = 50 Ω | - | 4 | 8 | ns |
| t _f | Fall Time | | - | 3.2 | 7 | ns |

Drain-Source Diode Characteristics

| I _S | Maximum Continuous Source Current | | - | - | 0.25 | Α |
|----------------|-----------------------------------|---|---|-----|------|---|
| V_{SD} | Source to Drain Diode Voltage | I _{SD} = 0.25A, V _{GS} = 0V | - | 0.8 | 1.2 | V |

Typical Characteristics

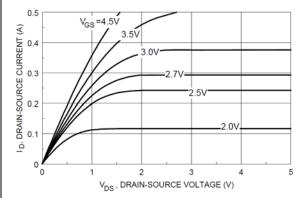


Figure 1. On-Region Characteristics.

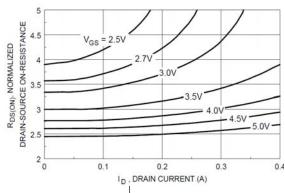


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

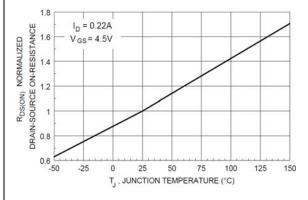


Figure 3. On-Resistance Variation with Temperature.

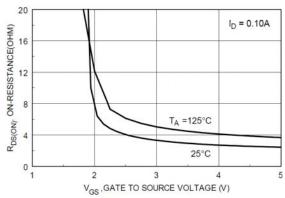


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

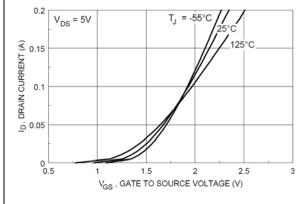


Figure 5. Transfer Characteristics.

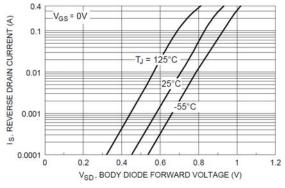
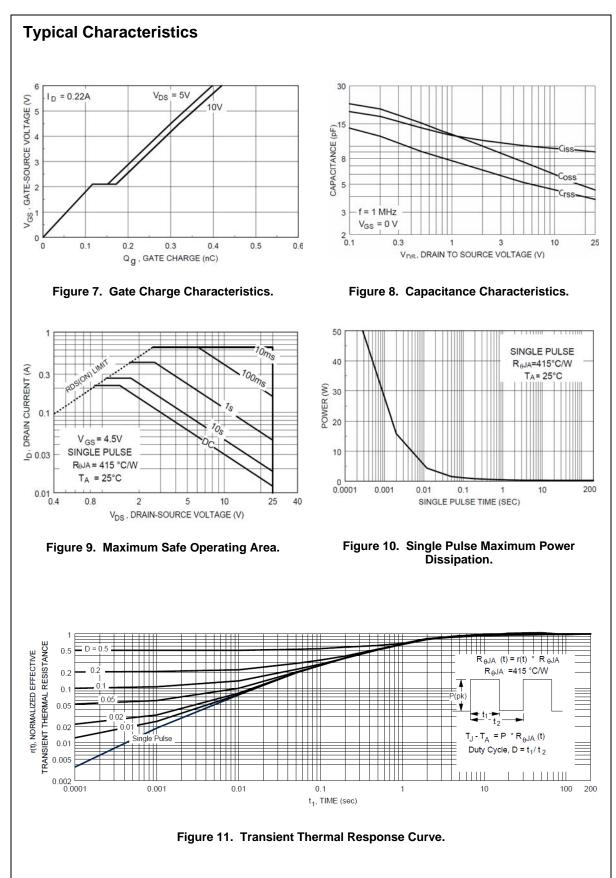
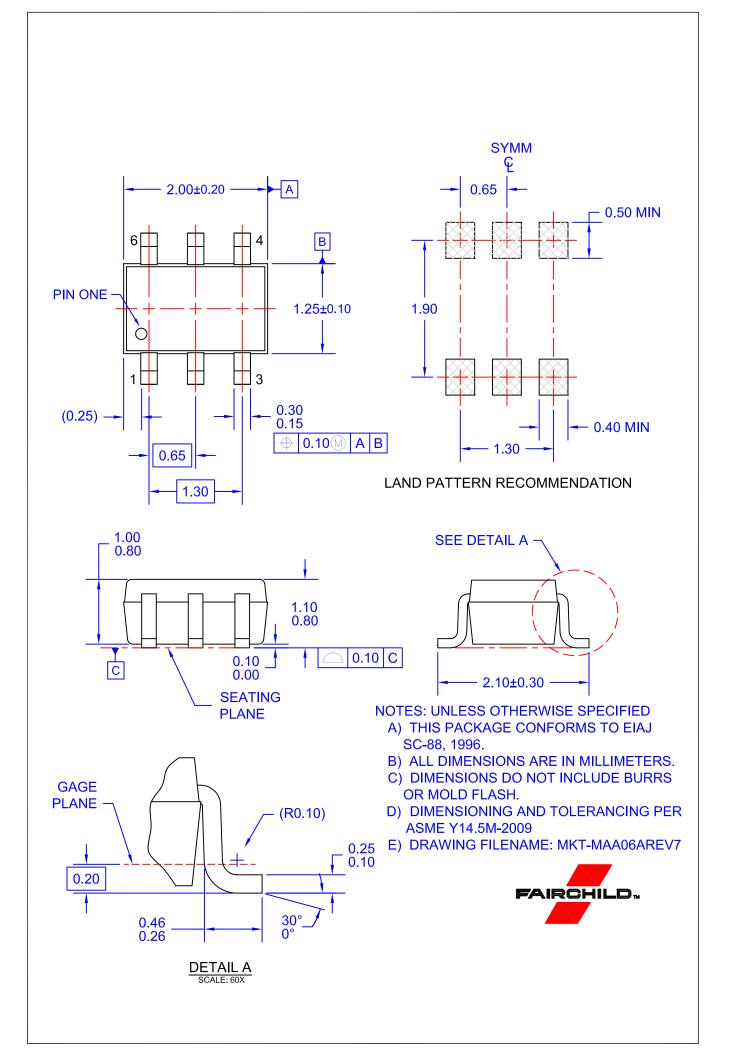


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.









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